## **EAST Search History**

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
S22	359	packag\$3 with stack\$3 with lid	USPAT; EPO; JPO	OR	ON	2006/02/21 15:14
S23	44	packag\$3 same stack\$3 with lid with (ic die chip semiconductor)	USPAT; EPO; JPO	OR	ON	2006/02/21 15:50
S24	3	packag\$3 with shield\$3 and stack\$3 with lid with (ic die chip semiconductor)	USPAT; EPO; JPO	OR	ON	2006/02/21 15:50
S25	20	packag\$3 same shield\$3 and stack\$4 with (cover cap lid) with (ic die chip semiconductor)	USPAT; EPO; JPO	OR	ON	2006/02/21 15:53
S26	70995	"438"/\$ packag\$3 and stack\$4 with (cover cap lid) with (ic die chip semiconductor)	USPAT; EPO; JPO	OR	ON	2006/02/21 15:54
S27	103	"438"/\$ and packag\$3 and stack\$4 with (cover cap lid) with (ic die chip semiconductor)	USPAT; EPO; JPO	OR	ON	2006/02/21 18:13
S28	3	("5579207"   "6493229"   "6525942").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2006/02/21 15:58
S29	29	("5523622"   "5572405"   "5598321"   "5705851"   "5719440"   "5724232"   "5729432"   "5793118"   "5818698"   "5854507"   "5866953"   "5903052"   "5909057"   "5936305"   "5959353"   "5959356"   "6025648"   "6081037"   "6104093"   "6111313"   "6201301"   "6248951"   "6255143"   "6265772"   "6274929"   "6297960"   "6303997"   "6331939"   "6381141").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2006/02/21 15:58
S30	3	("5552633" "5763939" "6445591") .PN.	US-PGPUB; USPAT; EPO; JPO	OR	ON	2006/02/21 16:03
S31	14	("5523622"   "5572405"   "5598321"   "5705851"   "5719440"   "5724232"   "5729432"   "5793118"   "5818698"   "5854507"   "5866953"   "5903052"   "5936305"   "5959356").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2006/02/21 16:26
S32	49	("6122171").URPN.	USPAT	OR	ON	2006/02/21 16:26
S33	387	"438"/\$ and stack\$4 near4 (ic die chip semiconductor) same (cover cap lid)	USPAT; EPO; JPO	OR	ON	2006/02/21 18:21
S34	111	S33 and (reduc\$3 minimiz\$3) with (size weigth shape dimension)	USPAT; EPO; JPO	OR	ON	2006/02/21 18:16

## **EAST Search History**

S35	3	("5471011"   "5757075"   "5773879").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2006/02/21 18:19
S36	4	("6091142").URPN.	USPAT	OR	ON	2006/02/21 18:20
S37	51	"257"/\$ and stack\$4 near4 (ic die chip semiconductor) same (cover cap lid) and (reduc\$3 minimiz\$3) with (size weigth shape dimension) not S34	USPAT; EPO; JPO	OR	ON	2006/02/21 18:40
S38	21	("4278991"   "4460825"   "4996587"   "5048179"   "5223741"   "5280192"   "5331203"   "5357056"   "5384689"   "5689091"   "5723900"   "5723901"   "5723907"   "5736780"   "5736981"   "5739585"   "5801439"   "5811879"   "5835988"   "5895970"   "5939782").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2006/02/21 18:23
S39	309	"257"/\$ and stack\$4 near4 (ic die chip semiconductor) same (cover cap lid) and "438"/\$	USPAT; EPO; JPO	OR	ON	2006/02/21 18:40
S40	3	("5579207"   "6493229"   "6525942").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2006/02/21 18:42
S41	3	("6316289"   "6352879"   "6620649").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2006/02/21 18:44
S42	4	("4807021"   "5952714"   "5973337"   "6049074").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2006/02/21 18:45